

Product Texts

LNP THERMOCOMP LC004XXP compound is based on Polyetheretherketone (PEEK) resin containing 20% carbon fiber. Added features of this grade include: Electrically Conductive.

Mechanical properties	Value	Unit	Test Standard
ISO Data			
Yield stress	199	MPa	ISO 527
Strain at break	1.9	%	ISO 527
Flexural modulus	13900	MPa	ISO 178
Izod impact strength, +23°C, 4mm	45	kJ/m ²	ISO 180/1U
Izod notched impact strength, +23°C, 4mm	10	kJ/m ²	ISO 180/1A

Electrical properties	Value	Unit	Test Standard
ASTM Data			
Surface Resistivity	10000	Ohm	ASTM D 257

Other properties	Value	Unit	Test Standard
Density	1360	kg/m ³	ISO 1183

Processing Recommendation Injection Molding	Value	Unit	Test Standard
Pre-drying - Temperature	120 - 150	°C	-
Pre-drying - Time	4	h	-
Processing humidity	≤0.1	%	-
Melt temperature	380 - 390	°C	-
Mold temperature	140 - 165	°C	-
Zone 1	350 - 360	°C	-
Zone 2	365 - 375	°C	-
Zone 3	380 - 395	°C	-
Screw speed	60 - 100	rpm	-
Back pressure	0.3 - 0.7	MPa	-

Characteristics**Processing**

Injection Molding

Regional Availability

North America, Europe, Asia Pacific

Special Characteristics

Increased electrical conductivity